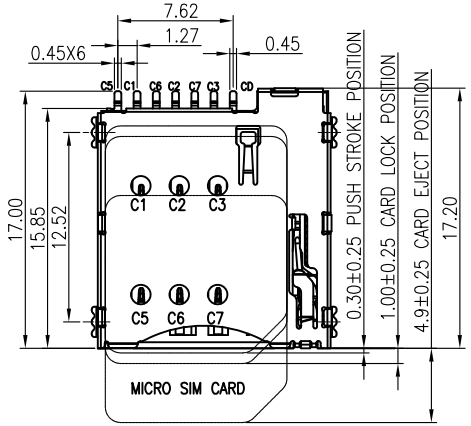
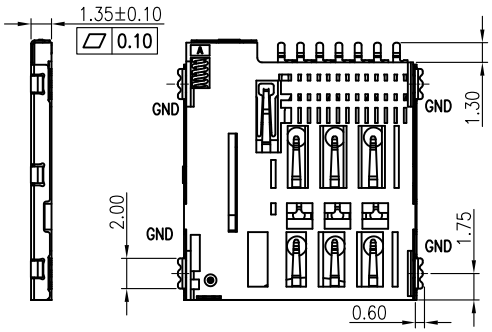
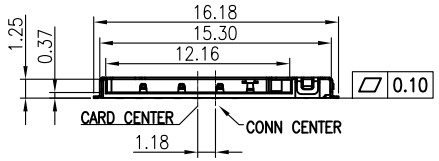
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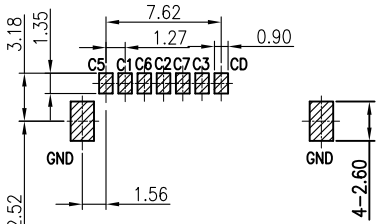
DATE: _____ TITLE: _____

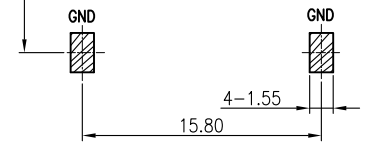
Rev	AWO #	Description	Date	Appr
-		RELEASED	11/24/14	
A		ADDED DIM.	8/6/15	AY/OC
B		UPDATED DRAWING	10/26/15	HR/OC
C		UPDATED DRAWING	6/27/19	OW/YC



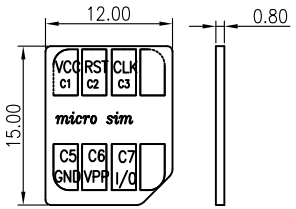




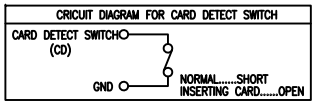




SIM pin Assignment	
PIN#	Name
C1	VCC
C2	RST
C3	CLK
C5	GND
C6	VPP
C7	I/O



MICRO SIM CARD



■ CIRCUT TRACE KEEP OUT AREA

▨ SMT SOLDER AREA

THERE SHOULD NOT BE ANY CIRCUITRIES IN THE LAYOUT SPACE OF THE PRODUCTS.

RECOMMENDED PCB LAYOUT

GENERAL TOLERANCE ±0.05

PACKAGED ON TAPE & REEL

SPECIFICATIONS:

Material:

Insulator: Hi-Temp Thermoplastic, UL94V-0, Color: Black

Contact: Copper Alloy

Shell: Stainless, Nickel plated, Gold plated on contact area

Plating:

Gold flash over Nickel underplate on contact area

Tin over Nickel underplate on solder tails

Electrical:

Current rating: 0.5 mA max

Voltage rating: 50 VDC max

Contact resistance: 100 mohms Max.

Insulation resistance: 1,000 Mohms min @ 250 VDC

Dielectric withstanding voltage: 500 VAC

Temperature Rating:

Ambient temperature range: -20°C to +85°C

Storage temperature range: -40°C to +70°C

Environmental:

Lead free, RoHS compliant

RoHS COMPLIANT

UNLESS OTHERWISE SPECIFIED
ALL DIMENSIONS ARE MILLIMETERS
TOLERANCES: EXCEPT AS NOTED

MM	ANGLE
.X ± 0.30	X.° ±2°
.XX ± 0.20	
.XXX ± 0.10	

APPROVALS		DATE
DRAWN	HR	11/24/14
CHECKED	NP	11/24/14
APPROVED		

ADAM TECH
INTERCONNECTS
909 Rahway Avenue,
Union, NJ 07083
Phone: 908-687-5000
Fax: 908-687-5710

TITLE: MICRO SIM CARD CONNECTOR, PUSH-PUSH TYPE, 6 PIN, SEL-GOLD PLATED, TAPE & REEL

SIZE	PART NO.	REV.
X	MSCCP-A-06-SG-SW-T/R	C

REF: S00108C | SCALE: NTS | SHEET 1 OF 1